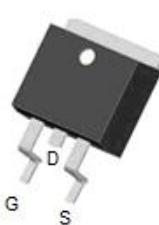
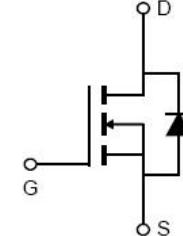


QIAOXIN N-Channel Super Trench II Power MOSFET

<p>Description</p> <p>The series of devices uses Super Trench II technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g. This device is ideal for high-frequency switching and synchronous rectification.</p> <p>Application</p> <ul style="list-style-type: none"> ● DC/DC Converter ● Ideal for high-frequency switching and synchronous rectification 	<p>General Features</p> <ul style="list-style-type: none"> ● $V_{DS} = 85V, I_D = 140A$ ● $R_{DS(ON)} = 3.4m\Omega$, typical (TO-220)@ $V_{GS} = 10V$ ● $R_{DS(ON)} = 3.2m\Omega$, typical (TO-263)@ $V_{GS} = 10V$ ● Excellent gate charge x $R_{DS(on)}$ product(FOM) ● Very low on-resistance $R_{DS(on)}$ ● 175 °C operating temperature ● Pb-free lead plating
<p>TO-220</p>  <p>TO-263</p> 	 <p>Schematic Diagram</p>

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VCRR040N85M	VCRR040N85M	TO-220	-	-	-
VCRR040N85MD	VCRR040N85MD	TO-263	-	-	-

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	85	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	140	A
Drain Current-Continuous($T_c=100^\circ C$)	$I_D (100^\circ C)$	105	A
Pulsed Drain Current	I_{DM}	560	A
Maximum Power Dissipation	P_D	200	W
Derating factor		1.33	W/°C
Single pulse avalanche energy (Note 1)	E_{AS}	1000	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case	R _{θJC}	0.75	°C/W
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Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	85		-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =85V, V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA	
On Characteristics							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.0	3.0	4.0	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =70A	TO-220	-	3.4	3.9	mΩ
			TO-263	-	3.2	3.9	mΩ
Forward Transconductance	g _{Fs}	V _{DS} =5V, I _D =70A		90	-	S	
Dynamic Characteristics							
Input Capacitance	C _{iss}	V _{DS} =40V, V _{GS} =0V, F=1.0MHz	-	4050	-	PF	
Output Capacitance	C _{oss}		-	1000	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	35	-	PF	
Switching Characteristics (Note 2)							
Turn-on Delay Time	t _{d(on)}	V _{DD} =40V, I _D =70A V _{GS} =10V, R _G =1.6Ω	-	17	-	nS	
Turn-on Rise Time	t _r		-	10	-	nS	
Turn-Off Delay Time	t _{d(off)}		-	37	-	nS	
Turn-Off Fall Time	t _f		-	8	-	nS	
Total Gate Charge	Q _g	V _{DS} =40V, I _D =70A, V _{GS} =10V	-	75	-	nC	
Gate-Source Charge	Q _{gs}		-	17.7	-	nC	
Gate-Drain Charge	Q _{gd}		-	25.5	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _s =70A	-		1.2	V	
Diode Forward Current	I _s		-	-	140	A	
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 70A di/dt = 100A/μs	-	72	-	nS	
Reverse Recovery Charge	Q _{rr}		-	102	-	nC	

Notes:

- EAS condition : T_j=25°C, V_{DD}=-40V, V_G=-10V, L=0.5mH, R_g=25Ω
- Guaranteed by design, not subject to production
- These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=175°C. The SOA curve provides a single pulse rating.

Typical Electrical and Thermal Characteristics

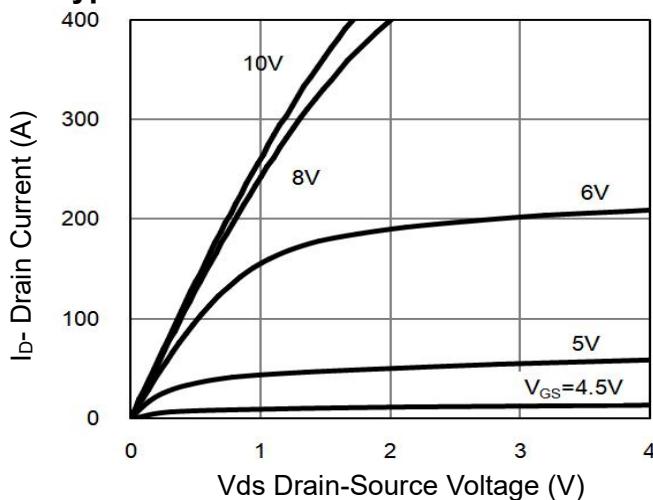


Figure 1 Output Characteristics

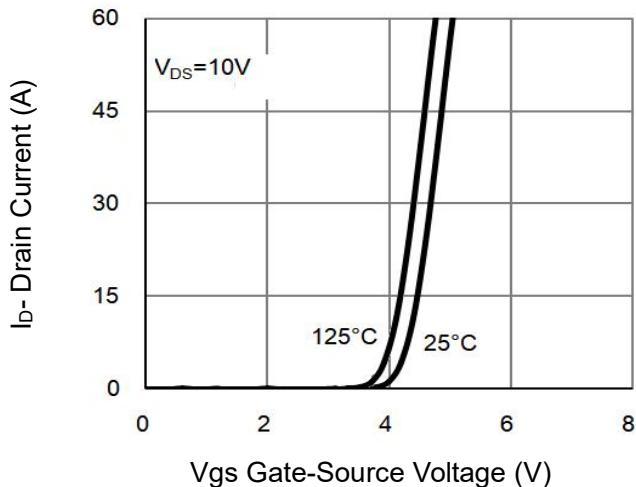


Figure 2 Transfer Characteristics

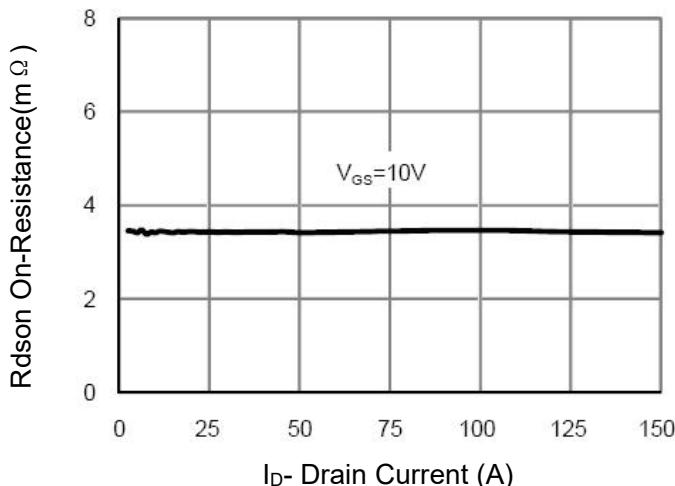


Figure 3 Rdson- Drain Current

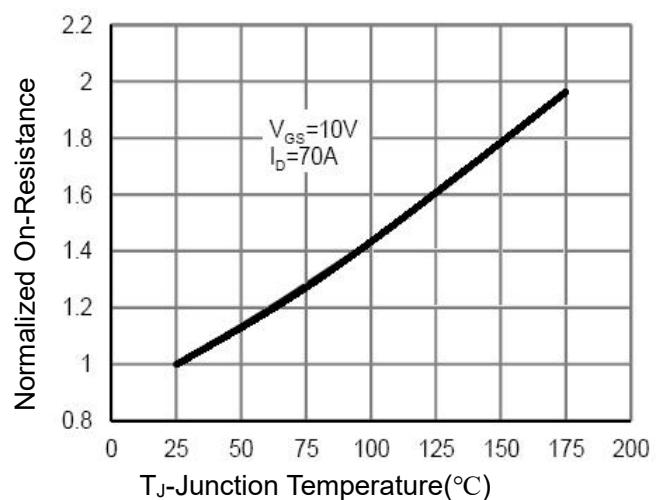


Figure 4 Rdson-Junction Temperature

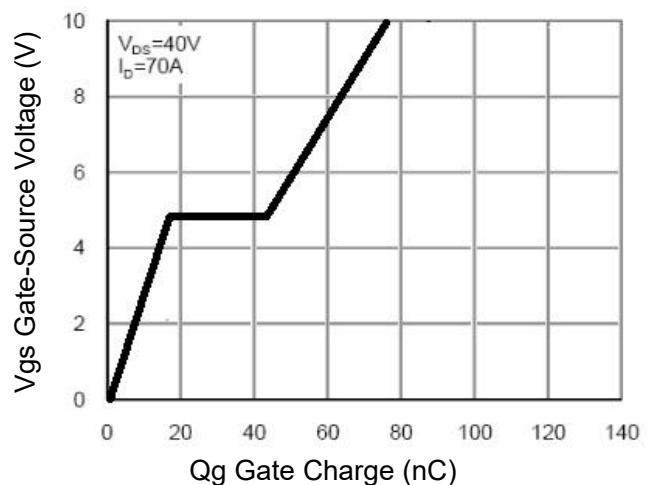


Figure 5 Gate Charge

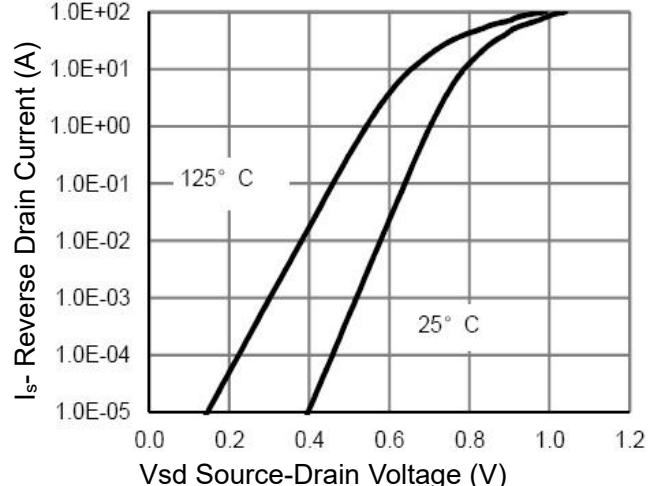


Figure 6 Source- Drain Diode Forward

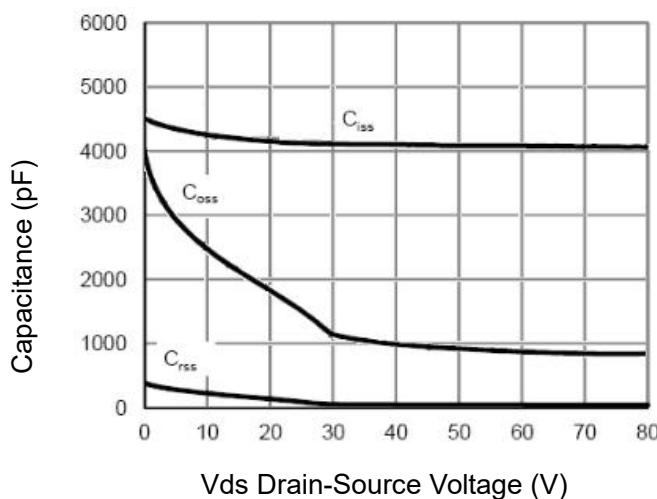


Figure 7 Capacitance vs Vds

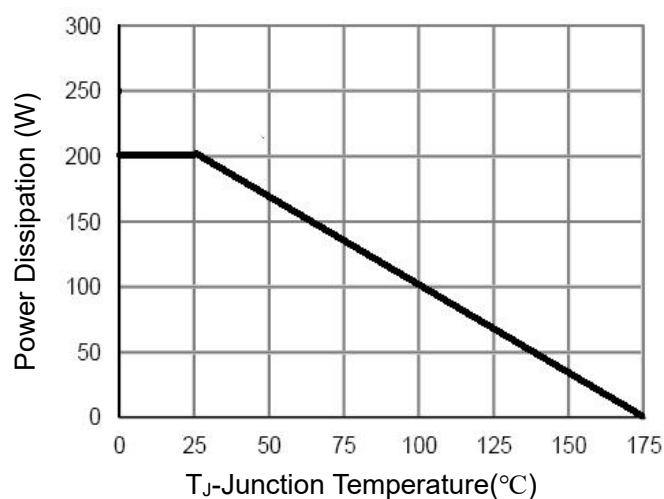


Figure 9 Power De-rating

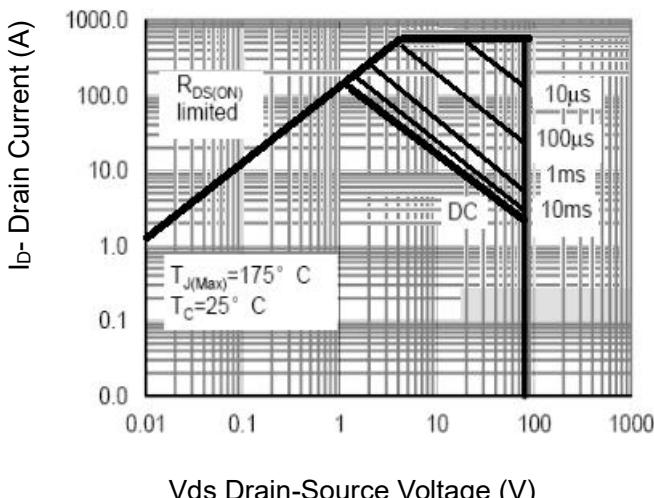


Figure 8 Safe Operation Area (Note3)

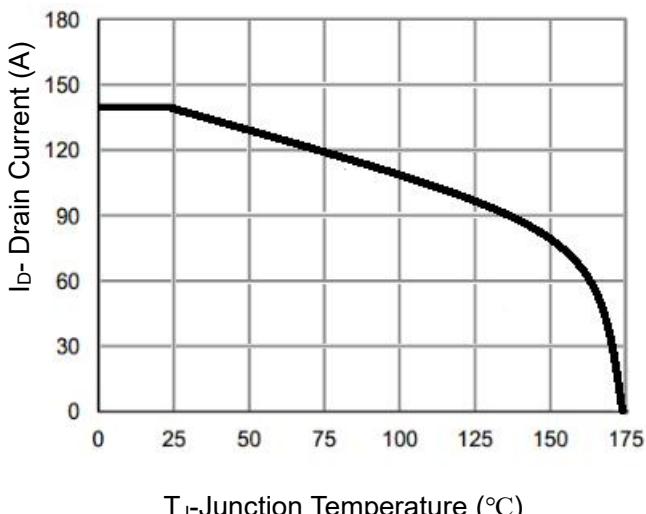


Figure 10 Current De-rating

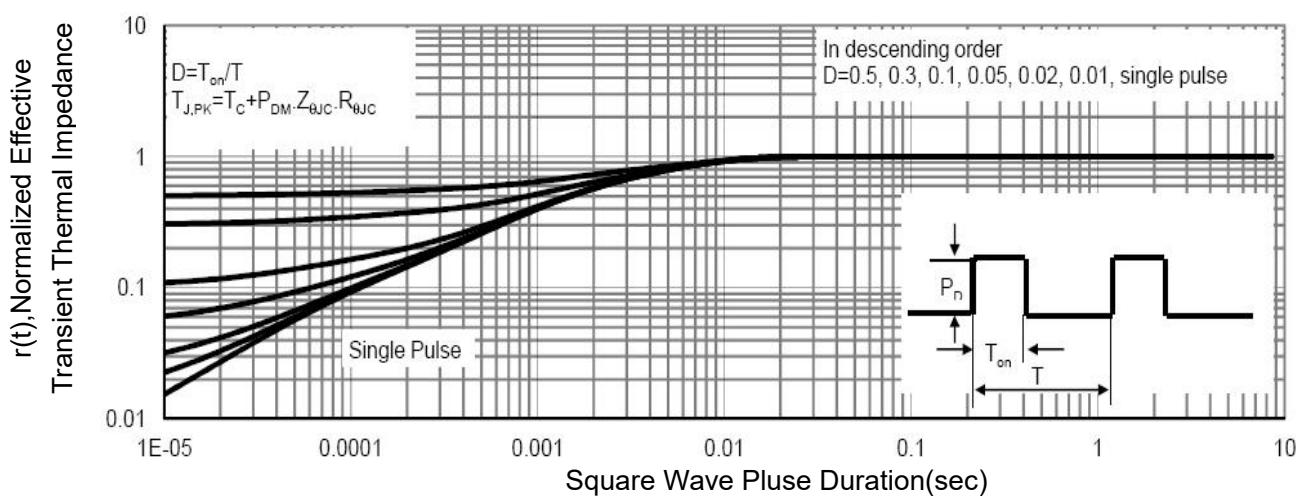
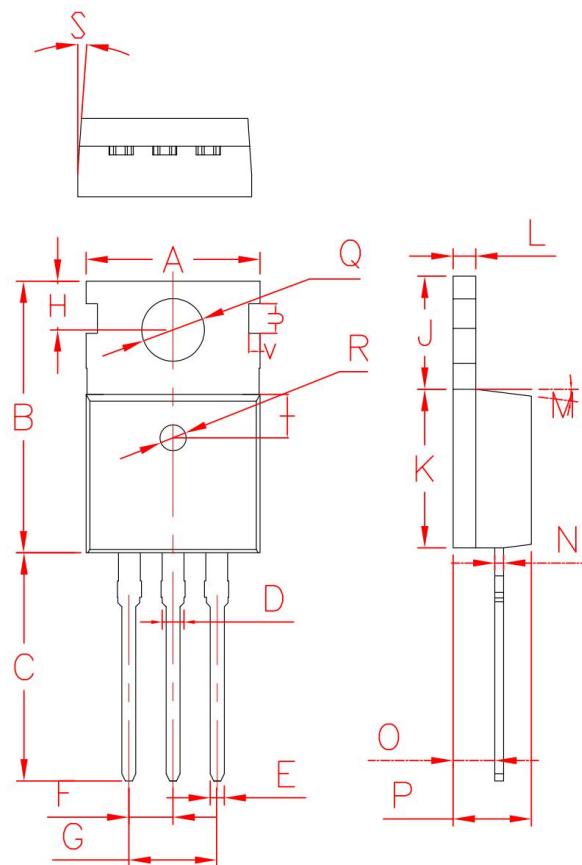


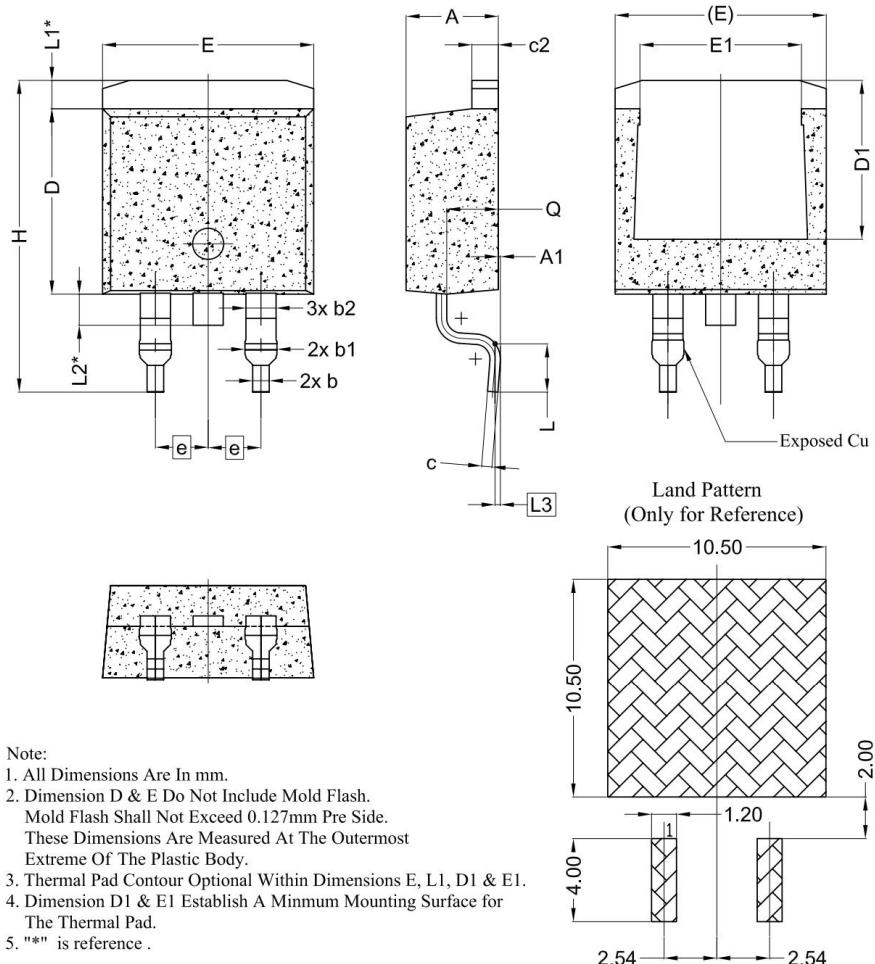
Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220-3L Package Information



Symbol	Min	Non	Max
A	9.80	10.00	10.20
B	15.40	15.60	15.80
C	12.75	13.10	13.45
D	1.18	1.31	1.44
E	0.70	0.80	0.90
F	2.42	2.54	2.66
G	4.84	5.08	5.32
H	2.73	2.80	2.87
I	2.40	2.50	2.60
J	6.40	6.50	6.60
K	9.00	9.10	9.20
L	1.29	1.30	1.32
M	6.5°	7.0°	7.5°
N	0.48	0.50	0.56
O	2.35	2.4	2.5
P	4.4	4.5	4.7
Q	3.5	3.6	3.63
R	1.4	1.5	1.6
S	2°	2.5°	3°
U	1.65	1.75	1.85
V	0.58	0.68	0.78

TO-263-3L Package Information



SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	4.24	4.44	4.64
A1	0.00	0.10	0.25
b	0.70	0.80	0.90
b1	1.20	1.55	1.75
b2	1.20	1.45	1.70
c	0.40	0.50	0.60
c2	1.15	1.27	1.40
D	8.82	8.92	9.02
D1	6.86	7.65	—
E	9.96	10.16	10.36
E1	6.89	7.77	7.89
e	2.54 BSC		
H	14.61	15.00	15.88
L	1.78	2.32	2.79
L1	1.36 REF.		
L2	1.50 REF.		
L3	0.25 BSC		
Q	2.30	2.48	2.70

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